

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
2	Inner Layer 1	0.035mm	ED Base Copper			
		0.710mm	Core IPC-4101/21	4,7	0,02	FR-4.0
3	Inner Layer 2	0.035mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
4	Inner Layer 3	0.035mm	ED Base Copper			
		0.710mm	Core IPC-4101/21	4,7	0,02	FR-4.0
5	Inner Layer 4	0.035mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
6	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
<b>Total thickness: 2.035mm</b>						

**BASIC6\_ML6\_1,6  
2\_35\_V2.12**

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:  
► [www.we-online.com](http://www.we-online.com)

**BASIC6\_ML6\_2,04\_35\_V2.12**

PCB Thickness Tolerance: ± 10%

customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			

Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen

